

# Off-Line Primary Side Sensing Converter with PFC

Check for Samples: TPS92311

## **FEATURES**

- Integrated 600V Power MOSFET With Superior Avalanche Energy Capability
- Regulates LED Current Without Secondary Side Sensing
- Adaptive ON-Time Control With Inherent PFC
- Critical-Conduction-Mode (CRM) With Zero-Current Detection (ZCD) for Valley Switching
- Programmable Switch Turn ON Delay
- Programmable Constant ON-Time (COT) and Peak Current Control
- Over-Temperature Protection

## **APPLICATIONS**

- LED Lamps: A19 (E26/27, E14), PAR30/38, GU10
- Solid State Lighting

### DESCRIPTION

The TPS92311 is an off-line converter specifically designed to drive high power LEDs for lighting applications. Features include an integrated 3.75Ω 600V power MOSFET, adaptive constant on-time control, quasi-resonant switching, and capable of operating in various topologies via mode selection pins. The TPS92311 is ideally suited for driving 8W LED loads and below. Power Factor Correction is inherent if the TPS92311 is operated in the constant on-time mode with an adaptive algorithm. Resonant switching allows for a reduced EMI signature and increased system efficiency. Low external parts count is realized with its simplified and high level of integration. The control algorithm of TPS92311 adjusts the on time with reference to the primary side inductor peak current and secondary side inductor discharge time dynamically, the response time of which is set by an external capacitor. Other supervisory features of the TPS92311 include cycleby-cycle primary side inductor current limit, VCC under-voltage lockout, output over-voltage protection and thermal shutdown. The TPS92311 is available in 16-pin narrow SOIC package.

## Typical Application

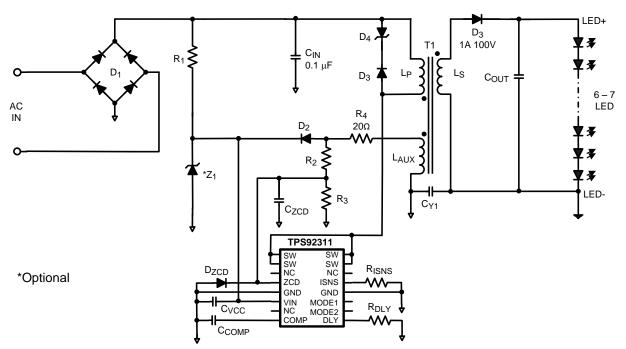


Figure 1. Typical Application

Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

All trademarks are the property of their respective owners.



## **Connection Diagram**

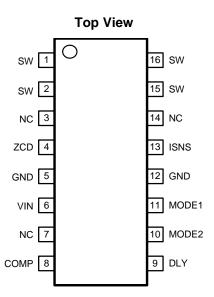


Figure 2. 16-Lead Narrow SOIC package

## **PIN DESCRIPTIONS**

Pin	Name	Description	Application Information
1, 2, 15, 16	SW	Drain	Internal power MOSFET drain pin
3, 7, 14	NC	No Connection	No connection pin
4	ZCD	Zero crossing detection input	The pin senses the voltage of the auxiliary winding for zero current detection.
5, 12	GND	Ground	Circuit ground.
6	VIN	Power supply Input	This pin provides power to the internal control
8	COMP	Compensation network	Output of the error amplifier. Connect a capacitor from this pin to ground to set the frequency response of the LED current regulation loop.
9	DLY	Delay control input	Connect a resistor from this pin to ground to set the delay between switching ON and OFF periods.
10	MODE2	Mode selection input 2	Select operating mode for isolated or non-isolated mode.
11	MODE1	Mode selection input 1	Select operating mode for peak current mode or constant ON time.
13	ISNS	Current sense voltage feedback	Switch current sensing input.





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings (1)(2)

	-9-		
SW to GND		-0.3V to 600	
VCC to GND		-0.3V to 40V	
DLY, COMP, ZCD to GND		-0.3V to 7V	
ISNS to GND		-0.3V to 7V	
MODE1 to GND		-0.3V to 7V	
MODE2 to GND		-0.3V to 7V	
SW FET Drain Current	Peak	1.2A	
	Continuous	Limited by T <sub>J-MAX</sub>	
Continuous Power Dissipation		Internally Limited	
ESD Susceptibility	HBM <sup>(3)</sup>	±2 kV	
Storage Temperature Range		-65°C to +150°C	
Junction Temperature (T <sub>J-MAX</sub> )		+125°C	
Maximum Lead Temperature (Solder and Reflow)		260°C	

- (1) Absolute maximum ratings are limits beyond which damage to the device may occur. Operating Ratings are conditions for which the device is intended to be functional, but device parameter specifications may not be ensured. For ensured specifications and test conditions, see the Electrical Characteristics. All voltages are with respect to the potential at the GND pin, unless otherwise specified.
- (2) If Military/Aerospace specified devices are required, please contact the Texas Instruments Sales Office/Distributors for availability and specifications.
- (3) Human Body Model, applicable std. JESD22-A114-C.

## **Operating Conditions**

Supply Voltage range VCC	13V to 36V
Junction Temperature (T <sub>J</sub> )	-40°C to +125°C
Thermal Resistance (θ <sub>JA</sub> ) <sup>(1)</sup>	95°C/W

(1) This R<sub>θJA</sub> typical value determined using JEDEC specifications JESD51-1 to JESD51-11. However junction-to-ambient thermal resistance is highly boardlayout dependent. In applications where high maximum power dissipation exists, special care must be paid to thermal dissipation issues during board design. In high-power dissipation applications, the maximum ambient temperature may have to be derated. Maximum ambient temperature (T<sub>J-MAX-OP</sub> = 125°C), the maximum power dissipation of the device in the application (P<sub>D-MAX</sub>), and the junction-to ambient thermal resistance of the part/package in the application (R<sub>θJA</sub>), as given by the following equation: T<sub>A-MAX</sub> = T<sub>J-MAX-OP</sub> - (R<sub>θJA</sub> × P<sub>D-MAX</sub>).



## **Electrical Characteristics**

 $V_{CC}$  = 18V unless otherwise indicated. Typicals and limits appearing in plain type apply for  $T_A$  =  $T_J$  = +25°C. Limits appearing in **boldface** type apply over the full Operating Temperature Range. Data sheet minimum and maximum specification limits are specified by design, test or statistical analysis.

are specifie	d by design, test or	statistical analysis.				1
Symbol	Parameter	Conditions	Min	Typ <sup>(1)</sup>	Max	Units
SUPPLY V	OLTAGE INPUT (VCC	)				
V <sub>CC-UVLO</sub>	VCC Turn on threshold		23.4 / <b>23</b>	25.6	27.8 / <b>29</b>	V
	VCCTurn off threshold		11.1 / <b>10.4</b>	13	14.7 <b>/ 15.7</b>	V
	Hysteresis			12.6		
I <sub>STARTUP</sub>	Startup Current	$V_{CC} = V_{CC-UVLO} - 3.0V$	10	12.5	14.75	μΑ
I <sub>VCC</sub>	Operating supply	Not switching	0.9	1.2	1.5	mA
	current	65kHz switching		2		mA
ZERO CRO	SS DETECT (ZCD)		•		•	
I <sub>ZCD</sub>	ZCD bais current	V <sub>ZCD</sub> = 5V		0.1	1	uA
V <sub>ZCD-OVP</sub>	ZCD over-voltage threshold		4.1	4.3	4.5	V
T <sub>OVP</sub>	Over voltage de- bounce time			3		cycle
V <sub>ZCD-ARM</sub>	ZCD Arming threshold	V <sub>ZCD</sub> = Increasing	1.16	1.24	1.3	V
V <sub>ZCD-TRIG</sub>	ZCD Trigger threshold	V <sub>ZCD</sub> = Decreasing	0.48	0.6	0.77	V
V <sub>ZCD-HYS</sub>	ZCD Hysteresis	V <sub>ZCD-ARM</sub> -V <sub>ZCD-TRIG</sub>		0.64		V
COMPENS	ATION (COMP)					
I <sub>COMP</sub> - SOURCE	Internal reference current for primary side current regulation	$V_{\text{COMP}}$ = 2.0V, $V_{\text{ISNS}}$ = 0V, Measure at COMP pin		27		μА
gm <sub>ISNS</sub>	ISNS error amp trans-conductance	$\Delta$ V <sub>ISNS</sub> to $\Delta$ I <sub>COMP</sub> @ V <sub>COMP</sub> = 2.0V		100		μmho
$V_{COMP}$	COMP operating range		2.0		3.5	V
DELAY CO	NTROL (DLY)				•	•
$V_{DLY}$	DLY pin internal reference voltage		1.21	1.23	1.26	V
I <sub>DLY-MAX</sub>	DLY source current	$V_{DLY} = 0V$	250			μA
CURRENT	SENSE (ISNS)					
V <sub>ISNS-OCP</sub>	Over Current Detection Threshold	Non isolation mode	0.56	0.61	0.68	V
V <sub>ISNS-OCP</sub>	Over Current Detection Threshold	Isolation mode	3.2	3.4	3.6	V
I <sub>ISNS</sub>	Current Sense Bias Current	V <sub>ISNS</sub> = 5V	-1		1	μA
T <sub>OCP</sub>	Over current Detection Propagation Delay	$R_{SNS}$ = 1K, Measure ISNS pin pulse width with $V_{SW}$ = 6V		210		ns
OUTPUT M	OSFET (SW FET)				1	1
V <sub>BVDS</sub>	SW to ISNS breakdown voltage		600	660		V

Product Folder Links: TPS92311

Submit Documentation Feedback

Typical numbers are at 25°C and represent the most likely norm.



## **Electrical Characteristics (continued)**

 $V_{CC}$  = 18V unless otherwise indicated. Typicals and limits appearing in plain type apply for  $T_A$  =  $T_J$  = +25°C. Limits appearing in **boldface** type apply over the full Operating Temperature Range. Data sheet minimum and maximum specification limits are specified by design, test or statistical analysis.

Symbol	Parameter	Conditions	Min	Typ <sup>(1)</sup>	Max	Units
I <sub>DS</sub>	SW to ISNS leakage current <sup>(2)</sup>	$V_{SW}$ - $V_{ISNS} = 600V$			1.35	μΑ
R <sub>DS</sub>	SW to ISNS switch on resistance			3.75		Ω
T <sub>ON-MIN</sub>	Minimum ON time		330	540	900	ns
T <sub>ON-MAX</sub>	Maximum ON time		28	44	58	μs
T <sub>OFF-MIN</sub>	Minimum OFF time		1.04	1.5	1.93	μs
T <sub>OFF-MAX</sub>	Maximum OFF time	$R_{SNS}$ = 1K, Measure ISNS pull-down period with $V_{SW}$ = 6V and $V_{ZCD}$ = 0V	50	70	94	μs
THERMAL	SHUTDOWN					
TSD	Thermal shutdown temperature	(3)		165		°C
	Thermal Shutdown hysteresis			20		°C

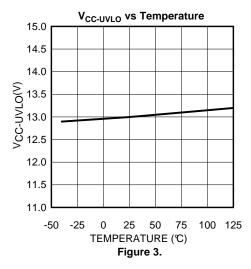
<sup>(2)</sup> High voltage devices such as the TPS92311 are susceptible to increased leakage currents when exposed to high humidity and high pressure operating environments. Users of this device are cautioned to satisfy themselves as to the suitability of this product in the intended end application and take any necessary precautions (e.g. system level HAST/HALT testing, conformal coating, potting, etc.) to ensure proper device operation.

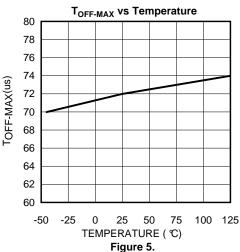
<sup>(3)</sup> Internal thermal shutdown circuitry protects the device from permanent damage. Thermal shutdown engages at T<sub>J</sub> = 165°C (typ.) and disengages at T<sub>J</sub> = 145°C (typ).

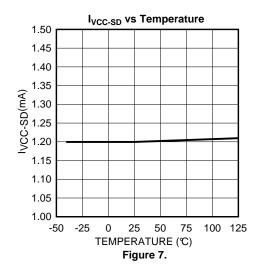


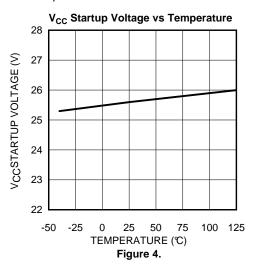
## **Typical Performance Characteristics**

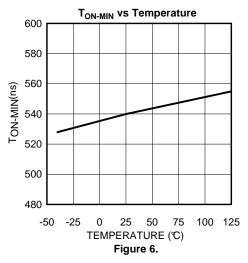
All curves taken at  $V_{CC}$ =18V with configuration in typical application for driving seven power LEDs with  $I_{LED}$ =350mA shown in this datasheet.  $T_A$ =25°C, unless otherwise specified.

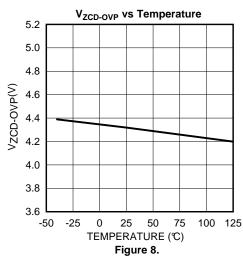










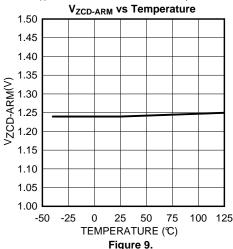


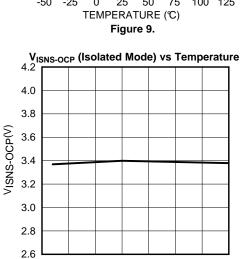
Submit Documentation Feedback



## **Typical Performance Characteristics (continued)**

All curves taken at  $V_{CC}$ =18V with configuration in typical application for driving seven power LEDs with  $I_{LED}$ =350mA shown in this datasheet.  $T_A$ =25°C, unless otherwise specified.





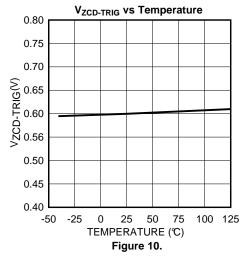
25

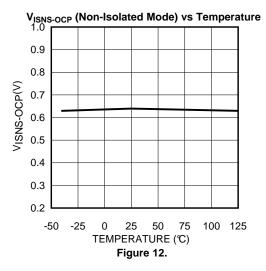
TEMPERATURE (℃)

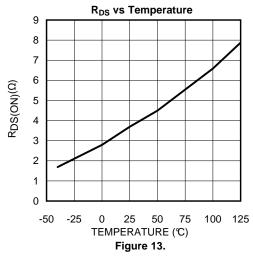
Figure 11.

50 75

100 125







Product Folder Links: TPS92311

-50 -25 0



## Simplified Internal Block Diagram

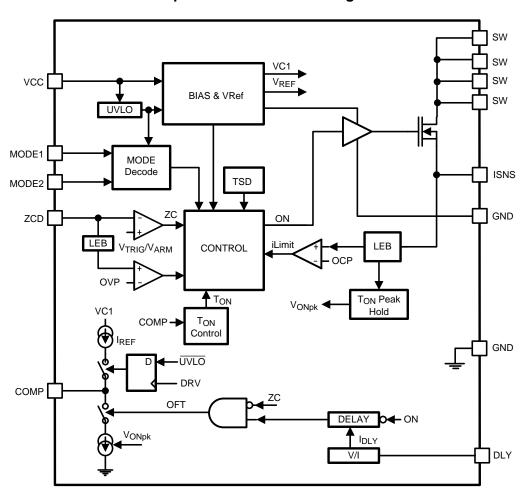


Figure 14. Simplified Block Diagram

### **APPLICATION INFORMATION**

The TPS92311 is an off-line convertor specifically designed to drive LEDs. This device operates in Critical Conduction Mode (CRM) with adaptive Constant ON-Time control, so that high power factor can be achieved naturally. The TPS92311can be configured as an isolated or non-isolated off-line converter. Please refer to TPS92311 typical application Figure 1, on the front page, in the following discussion. The TPS9231 flyback converter consists of a transformer which includes three windings L<sub>P</sub>, L<sub>S</sub> and L<sub>AUX</sub>, an internal MOSFET Q<sub>1</sub> and inductor current sensing resistor R<sub>ISNS</sub>. Secondary side components are secondary side transformer winding L<sub>S</sub>, output diode D<sub>3</sub>, and output capacitor C<sub>OUT</sub>. An auxiliary winding is required, and serves two functions. Auxiliary power is developed from the winding to power the TPS92311 after start-up, and detect the zero crossing point due to the end of a complete switching cycle. During the on-period, Q<sub>1</sub> is turned on, and current flows through L<sub>P</sub>, Q<sub>1</sub> and R<sub>ISNS</sub> to ground, input energy is stored in the primary inductor L<sub>P</sub>. Simultaneously, the I<sub>SNS</sub> pin of the device monitors the voltage of the current sensing resistor RISNS to perform the cycle-by-cycle inductor current limit function. During the time MOSFET Q1 is off, current flow in LP ceases and the energy stored during the on cycle is released to output and auxiliary circuits. During Q<sub>1</sub> off-time current in the secondary winding L<sub>S</sub>charges the output capacitor C<sub>OUT</sub> through D<sub>3</sub> and supplies the LED load. During Q<sub>1</sub> on-time, C<sub>OUT</sub> is responsible to supply load current to LED load during subsequent on-period. Also during Q1 off-time current is delivered to the auxiliary winding through D2 and powers the TPS92311. The voltage across LAUX, VLAUX is fed back to the ZCD pin through a resistor divider network formed by R<sub>2</sub> and R<sub>3</sub> to perform zero crossing detection of V<sub>IAUX</sub>, which determines the end of the off-period of a switching cycle. The next on period of a new cycle will be initiated after an inserted delay of 2 x t<sub>DLY</sub>. The t<sub>DLY</sub> is programmable by a single resistor connecting the DLY pin and ground.

Submit Documentation Feedback



The setting of the delay time,  $t_{DLY}$  will be described in a separate paragraph. During steady state operation, the duration of the on-period  $t_{ON}$  can be determined with two different modes: the Constant On-Time (COT) mode and the Peak Current Mode (PCM), which are configured by setting the MODE1 and MODE2 pins. For the COT mode,  $t_{ON}$  is generated by comparing an internal generated saw-tooth waveform with the voltage on the COMP pin ( $V_{COMP}$ ). Since  $V_{COMP}$  is slow varying,  $t_{ON}$  is nearly constant within an AC line cycle. For the PCM, the onperiod is terminated when the voltage of the ISNS pin ( $V_{ISNS}$ ) reaches a threshold determined by  $V_{COMP}$ . Since the instantaneous input voltage (AC voltage) varies,  $t_{ON}$  varies accordingly within an AC line cycle. The duration of the off-period ( $t_{OFF}$ ) is determined by the rate of discharging of the secondary current through the transformer. Also,

$$I_{LS-PEAK} = n x I_{LP-PEAK}$$
(1)

where n is the turn ratio of L<sub>P</sub> and L<sub>S</sub>. Figure 15 shows the typical waveforms in normal operation.

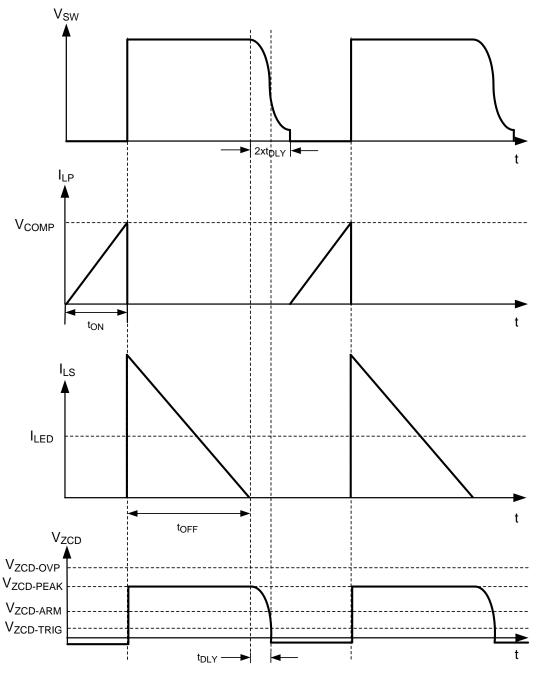


Figure 15. Primary and Secondary Side Current Waveforms



## Startup Bias and UVLO

During startup, the TPS92311 is powered from the AC line through  $R_1$  and  $D_1$  (Figure 1). In the startup state, most of the internal circuits of the TPS92311 are shut down in order to minimize internal quiescent current. When  $V_{CC}$  reaches the rising threshold of the  $V_{CC-UVLO}$  (typically 25.6V), the TPS92311 is operating in a low switching frequency mode, where  $t_{ON}$  and  $t_{OFF}$  are fixed to 1.5µs and 72µs. When  $V_{ZCD-PEAK}$  is higher than  $V_{ZCD-ARM}$ , the TPS92311 enters normal operation.

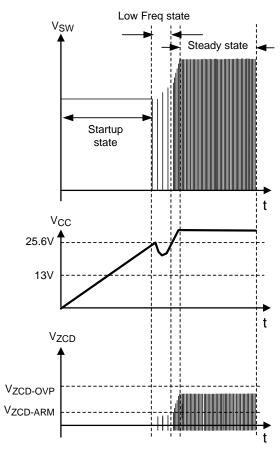


Figure 16. Start up Bias Waveforms

### **Mode Decoder**

The TPS92311 is capable of operating in two control modes as an isolated topology, Peak Current Mode (PCM) or Constant On-Time (COT). The TPS92311 can also be configured in a non-isolated topology using COT operation. Depending on system requirements, the designer will chose between the two modes of operation. COT mode gives a high power factor, PCM can achieve a lower output current ripple. COT mode using a non-isolated topology can achieve a higher efficiency and good load regulation. The above modes can be selected by setting the MODE1 and MODE2 pins according to Table 1.

**Table 1. MODE Configuration** 

MODE1	MODE2	Mode of operation
OPEN	OPEN	COT mode using isolated topology
GND	OPEN	PCM using isolated topology
OPEN	GND	COT mode using non-isolated topology
GND	GND	Reserved



## **Zero Crossing Detection**

To minimized the switching loss of the internal power MOSFET, a zero crossing detection circuit is embedded in the TPS92311.  $V_{LAUX}$  is AC voltage coupled from  $V_{SW}$  by means of the transformer, with the lower part of the waveform clipped by  $D_{ZCD}$ .  $V_{LAUX}$  is fed back to the ZCD pin to detect a zero crossing point through a resistor divider network which consists of  $R_2$  and  $R_3$ . The next turn on time of  $Q_1$  is selected  $V_{SW}$  is the minimum, an instant corresponding to a small delay after the zero crossing occurs. (Figure 17) The actual delay time depends on the drain capacitance of the  $Q_1$  and the primary inductance of the transformer ( $L_P$ ). Such delay time is set by a single external resistor as described in Delay Setting section.

During the off-period at steady state,  $V_{ZCD}$  reaches its maximum  $V_{ZCD-PEAK}$  (Figure 15), which is scalable by the turn ratio of the transformer and the resistor divider network  $R_2$  and  $R_3$ . It is recommended that  $V_{ZCD-PEAK}$  is set to 3V during normal operation.

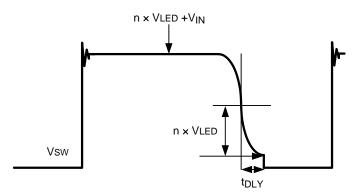


Figure 17. Switching Node Waveforms

## **Delay Time Setting**

In order to reduce EMI and switching loss, the TPS92311 inserts a delay between the off-period and the on-period. The delay time is set by a single resistor which connects across the DLY pin and ground, and their relationship is shown in Figure 18. The optimal delay time depends on the resonance frequency between  $L_P$  and the drain to source capacitance of  $Q_1$  ( $C_{DS}$ ). Circuit designers should optimize the delay time according to the following equation.

$$f_{SW} = \frac{1}{2\pi\sqrt{L_{P}C_{DS}}}$$

$$t_{DLY} = \frac{\pi\sqrt{L_{P}C_{DS}}}{2}$$
(2)

After determining the delay time,  $t_{DLY}$  can be implemented by setting  $R_{DLY}$  according to the following equation:

$$R_{DLY} = K_{DLY}(t_{DLY} - 105 ns)$$

where

•  $K_{DLY} = 32M\Omega/ns$  is a constant. (4)

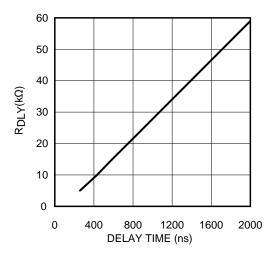


Figure 18. Delay Time Setting

#### **Protection Features**

### **OUTPUT OPEN CIRCUIT PROTECTION**

If the LED string is disconnected from the output of the TPS92311, The output voltage ( $V_{LED}$ ) increases and thus  $V_{ZCD\text{-PEAK}}$  increases. When  $V_{ZCD\text{-PEAK}}$  is greater than  $V_{ZCD\text{-OVP}}$  for 3 continues switching cycles, the Over Voltage Protection (OVP) feature is triggered. Switching of  $Q_1$  is stopped, and  $V_{CC}$  decreases until it drops below the falling threshold of  $V_{CC\text{-UVLO}}$ , the TPS92311 restarts, and re-enter into startup state (Figure 20).

## **OUTPUT SHORT CIRCUIT PROTECTION**

If the LED string is shorted,  $V_{ZCD\text{-PEAK}}$  drops, and as  $V_{ZCD\text{-PEAK}}$  drops below  $V_{ZCD\text{-TRIG}}$ , the TPS92311 will enter low switching frequency operation. During low switching frequency operation, power supplied from  $L_{AUX}$  to  $V_{CC}$  is not enough to maintain  $V_{CC}$ . If the short remains  $V_{CC}$  will drop below the falling threshold of  $V_{CC\text{-UVLO}}$ , the TPS92311 will attempt to restart at this time (Figure 19). When the short is removed the TPS92311 will restore to steady state operation.



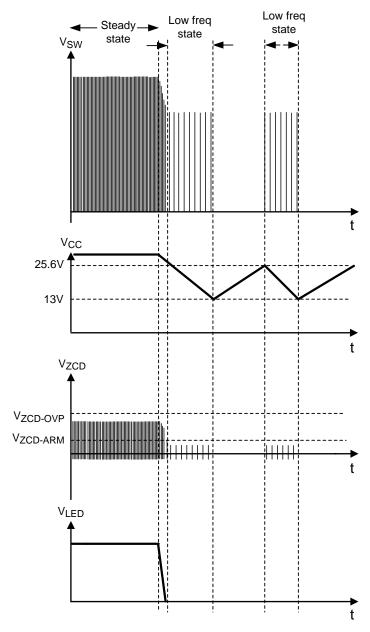


Figure 19. Output Short Circuit waveforms

### **OVER CURRENT PROTECTION**

Over Current Protection (OCP) limits the drain current of internal MOSFET and prevents inductor / transformer saturation. When  $V_{\rm ISNS}$  reaches a threshold, the OCP is triggered and the internal MOSFET will turn off immediately. The threshold is typically 3.4V and 0.64V when the TPS92311 is using an isolated topology and a non-isolated topology respectively.

## THERMAL PROTECTION

Thermal protection is implemented by an internal thermal shutdown circuit, which activates at 160°C (typically). In this case, the internal switching power MOSFET will turn off. Capacitor  $C_{VCC}$  will discharge until UVLO. When the junction temperature of the TPS92311 falls back below 130°C, the TPS92311 resumes normal operation.



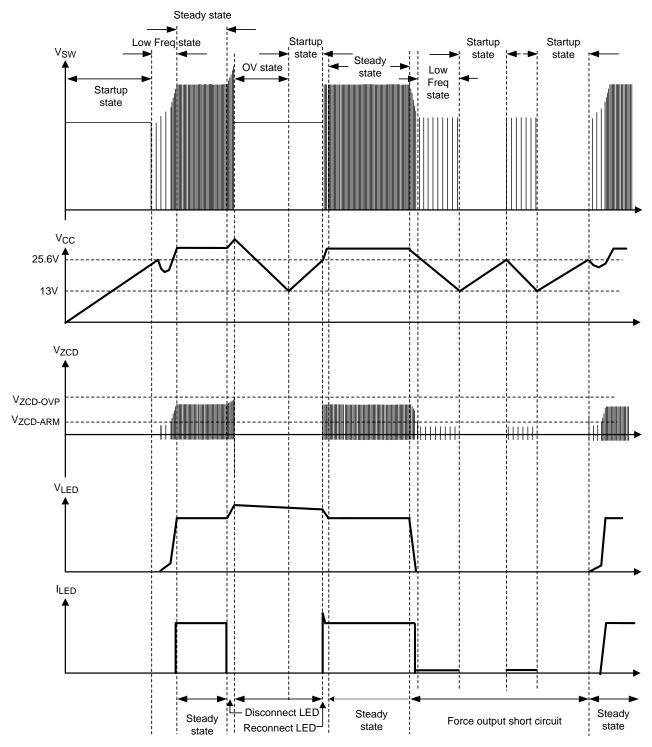


Figure 20. Auto Restart Operation



#### DESIGN EXAMPLE

The following design example illustrates the procedures to calculate the external component values for the TPS92311 isolated single stage fly-back LED driver with PFC.

### **Design Specifications:**

Input voltage range, V<sub>AC RMS</sub> = 85VAC - 132VAC

Nominal input voltage, V<sub>AC RMS(NOM)</sub> = 110VAC

Number of LED in serial =7

LED current, I<sub>LED</sub> = 350mA

Forward voltage drop of single LED = 3.0V

Forward voltage of LED stack,  $V_{LED} = 21V$ 

### **Key operating Parameters:**

Converter minimum switching frequency, f<sub>SW</sub> = 75kHz

Output rectifier maximum reverse voltage, V<sub>D3(MAX)</sub> = 100V

Power MOSFET rating,  $V_{Q1(MAX)} = 600V (3.75\Omega)$ 

Power MOSFET Output Capacitance,  $C_{DS} = 37pF$  (estimated)

Nominal output power,  $P_{OUT} = 8W$ 

## START UP BIAS RESISTOR

During start up, the  $V_{CC}$  will be powered by the rectified line voltage through external resistor,  $R_1$ . The  $V_{CC}$  start up current,  $I_{VCC(SU)}$  must set in the range  $I_{VCC(MIN)} > I_{VCC(SU)} > I_{STARTUP(MAX)}$  to ensure proper restart operation during OVP fault. In this example, a value of 0.55mA is suggested. The resistance of  $R_1$  can be calculated by dividing the nominal input voltage in RMS by the start up current suggested.

So,  $R_1 = 110V/0.55mA = 200K\Omega$  is recommended.

### TRANSFORMER TURN RATIO

The transformer winding turn ratio, n is governed by the internal MOSFET Q1 maximum rated voltage,  $(V_{Q3(MAX)})$ , highest line input peak voltage  $(V_{AC-PEAK})$  and output diode maximum reverse voltage rating  $(V_{D3(MAX)})$ . The output diode rating limits the lower bound of the turn ratio and the internal power MOSFET rating provide the upper bound of the turn ratio. The transformer turn ratio must be selected in between the bounds. If the maximum reverse voltage of D3  $(V_{D3(MAX)})$  is 100V. the minimum transformer turn ratio can be calculated with the equation in below.

$$n > \frac{V_{AC-PEAK}}{(V_{D3(MAX)} - V_{LED})}$$
(5)

$$n > \frac{132x\sqrt{2}}{100-30} = 2.33$$

(6)



In operation, the voltage at the switching node,  $V_{SW}$  must be small than the internal MOSFET maximum rated voltage  $V_{Q1(MAX)}$ , For reason of safety, 10% safety margin is recommended. Hence, 90% of  $V_{Q1(MAX)}$  is used in the following equation.

$$n < \frac{V_{Q1(MAX)}x0.9 - V_{AC-PEAK} - V_{os}}{V_{LED(MAX)}}$$

$$n < \frac{600x0.9 - 132\sqrt{2} - 50}{30} = 12.1$$
(7)

where

• V<sub>os</sub> is the maximum switching node overshoot voltage allowed, in this example, 50V is assumed (8)

As a rule of thumb, lower turn ratio of transformer can provide a better line regulation and lower secondly side peak current. In here, turn ratio n = 3.8 is recommended.

#### SWITCHING FREQUENCY SELECTION

TPS92311 can operate at high switching frequency in the range of 60kHz to 150kHz. In most off-line applications, with considering of efficiency degradation and EMC requirements, the recommended switching frequency range will be 60kHz to 80kHz. In this design example, switching frequency at 75kHz is selected.

## **SWITCHING ON TIME**

The maximum power switch on-time,  $t_{ON}$  depends on the low line condition of  $85V_{AC}$ . At  $85V_{AC}$  the switching frequency was chosen at 75kHz. This transformer design will follow the formulae as shown below.

$$t_{ON} = \frac{1}{f_{sw} \left( \frac{V_{AC\_MIN\_PEAK}}{nxV_{LED}} + 1 \right)}$$

$$t_{ON} = \frac{1}{75000 \left( \frac{85\sqrt{2}}{3.8 \times 21} + 1 \right)} = 5.3 \,\mu\text{s}$$
(10)

## TRANSFORMER PRIMARY INDUCTANCE

The primary inductance,  $L_P$  of the transformer is related to the minimum operating switching frequency  $f_{SW}$ , converter output power  $P_{OUT}$ , system efficiency  $\eta$  and minimum input line voltage  $V_{AC\_RMS(MIN)}$ . For CRM operation, the output power,  $P_{OUT}$  can be described by the equation in below.

$$P_{OUT} = \eta x \frac{1}{2} L_{P} x I_{LP-PEAK}^{2} x f_{SW}$$
(11)

By re-arranging terms, the transformer primary inductance required in this design example can be calculated with the equation follows:

$$L_{P} = \frac{\eta x V_{AC\_RMS(MIN)}^{2} t_{ON}^{2}}{2 x P_{OUT} x \frac{1}{f_{sw}}}$$
(12)

The converter minimum switching frequency is 75kHz,  $t_{ON}$  is 5.3 $\mu$ s,  $V_{AC\_RMS(MIN)} = 85V$  and  $P_{OUT} = 8W$ , assume the system efficiency,  $\eta = 85\%$ . Then,

$$L_{P} = \frac{0.85 \times (85)^{2} \times (5.3 \,\mu)^{2}}{2 \times 8 \times 13.3 \,\mu} = 0.81 \,\text{mH} \tag{13}$$

From the calculation in above, the inductance of the primary winding required is 0.81mH.



### **Calculate The Current Sensing Resistor**

After the primary inductance and transformer turn ratio is determined, the current sensing resistor, R<sub>ISNS</sub> can be calculated.

The resistance for R<sub>ISNS</sub> is governed by the output current and transformer turn ratio, the equation in below can be used.

$$R_{ISNS} = n x \left( \frac{v_{REF}}{I_{LED}} \right)$$

where

Transformer turn ratio,  $N_P$ :  $N_S$  is 3.8 : 1 and  $I_{LED} = 0.35A$ 

$$R_{ISNS} = 3.8 \times \frac{0.14}{0.35} = 1.52 \Omega$$

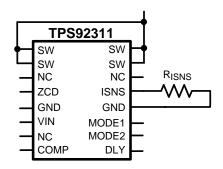


Figure 21. R<sub>ISNS</sub> Resistor Interface

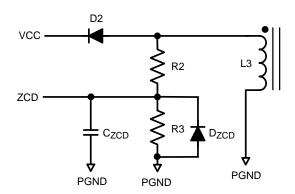


Figure 22. Auxiliary Winding Interface to ZCD

## **Auxiliary Winding Interface To ZCD**

In Figure 22, R2 and R3 forms a resistor divider which sets the thresholds for over voltage protection of  $V_{\text{LED}}$ ,  $V_{\text{ZCD-OVP}}$ , and  $V_{\text{ZCD-PEAK}}$ . Before the calculation, we need to set the voltage of the auxiliary winding,  $V_{\text{LAUX}}$  at open circuit.

#### For example:

Assume the nominal forward voltage of LED stack (V<sub>LED</sub>) is 21V.

To avoid false triggering  $ZCD_{OVP}$  voltage threshold at normal operation, select  $ZCD_{OVP}$  voltage at 1.3 times of the  $V_{LED}$  is typical in most applications. In case the transformer leakage is higher, the  $ZCD_{OVP}$  threshold can be set to 1.5 times of the  $V_{LED}$ .



In this design example, open circuit AUX winding OVP voltage threshold is set to 30V. Assume the current through the AUX winding is 0.4mA typical.

As a result, R2 is  $66k\Omega$  and R3 is  $11k\Omega$ . Also, for suppressing high frequency noise at the ZCD pin, a 15pF capacitor connects the ZCD pin to ground is recommended.

## Auxiliary Winding Vcc Diode Selection

The VCC diode D2 provides the supply current to the converter, low temperature coefficient, low reverse leakage and ultra fast diode is recommended.

## **Compensation Capacitor And Delay Timer Resistor Selection**

To achieve PFC function with a constant on time flyback converter, a low frequency response loop is required. In most applications, a  $3.3\mu F$  C<sub>COMP</sub> capacitor is suitable for compensation.

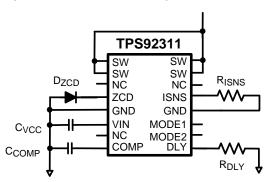


Figure 23. Compensation and DLY Timer connection

The resistor R<sub>DLY</sub> connecting the DLY pin to ground is used to set the delay time between the ZCD trigger to power MOSFET turn on. The delay time required can be calculated with the parasitic capacitance at the drain of MOSFET to ground and primary inductance of the transformer. Equation in below can be used to find the delay time and Figure 18 in previous page can help to find the resistance once the delay time is calculated

$$t_{DLY} = \frac{\pi \sqrt{L_P C_{DS}}}{2}$$
(16)

For example, using a transformer with primary inductance  $L_P = 1$ mH, and power MOSFET drain to ground capacitor  $C_{DS}=37$ pF, the  $t_{DLY}$  can be calculated by the upper equation. As a result,  $t_{DLY}=302$ ns and  $R_{DLY}$  is 6.31k $\Omega$ . The delay time may need to change according to the primary inductance of the transformer. The typical level of output current will shift if inappropriate delay time is chosen.

### **Output Flywheel Diode Selection**

To increase the overall efficiency of the system, a low forward voltage schottky diode with appropriate rating should be used.

## **Primary Side Snubber Design**

The leakage inductance can induce a high voltage spike when power MOSFET is turned off. Figure 24 illustrates the operation waveform. A voltage clamp circuit is required to protect the power MOSFET. The voltage of snubber clamp ( $V_{SN}$ ) must be higher than the sum of over shoot voltage ( $V_{OS}$ ), LED open load voltage multiplied by the transformer turn ratio (n). In this examples, the  $V_{OS}$  is 50V and LED maximum voltage,  $V_{LED(MAX)}$  is 30V, transformer turn ratio is 3.8. The snubber voltage required can be calculated with following equations.



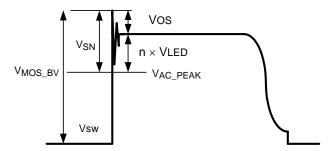


Figure 24. Snubber Waveform

$$V_{SN} > V_{OS} + V_{LED(MAX)} \times n$$

where

$$V_{SN} > 50V + 30V \times 3.8 = 164V$$
(18)

At the same time, sum of the snubber clamp voltage and  $V_{AC}$  peak voltage ( $V_{AC\_PEAK}$ ) must be smaller than the MOSFET breakdown voltage ( $V_{MOS\_BV}$ ). By re-arranging terms, equation in below can be used.

$$V_{SN} < V_{MOS\_BV} - V_{AC} \sqrt{2}$$
  
 $V_{SN} < 600 - 132 \times \sqrt{2} = 414V$ 
(19)

In here, snubber clamp voltage, V<sub>SN</sub> = 250V is recommended.

## **Output Capacitor**

The capacitance of the output capacitor is determined by the equivalent series resistance (ESR) of the LED,  $R_{LED}$  and the ripple current allowed for the application. The equation in below can be used to calculate the required capacitance.

$$C_{OUT} = \frac{\sqrt{\left(2\frac{I_{LED}}{\Delta I_{LED}}\right)^2 - 1}}{4 \times \pi \times f_{AC} R_{LED}}$$
(20)

Assume the ESR of the LED stack contains 7 LEDs and is 2.6Ω, AC line frequency f<sub>AC</sub> is 60Hz.

In this example, LED current I<sub>LED</sub> is 350mA and output ripple current is 30% of I<sub>LED</sub>:

$$C_{OUT} = \frac{\sqrt{\left(\frac{2x0.35}{0.3x0.35}\right)^2 - 1}}{4x\pi x60x7x2.6}$$
(21)

Then,  $C_{OUT} = 480 \mu F$ .

In here, a 470µF output capacitor with 10µF ceramic capacitor in parallel is suggested.



## **PCB Layout Considerations**

The performance of any switching power supplies depend as much upon the layout of the PCB as the component selection. Good layout practices are important when constructing the PCB. The layout must be as neat and compact as possible, and all external components must be as close as possible to their associated pins. High current return paths and signal return paths must be separated and connect together at single ground point. All high current connections must be as short and direct as possible with thick traces. The SW pin of the internal MOSFET should be connected close to the transformer pin with short and thick trace to reduce potential electro-magnetic interference. For off-line applications, one more consideration is the safety requirements. The clearance and creepage to high voltage traces must be complied to all applicable safety regulations.

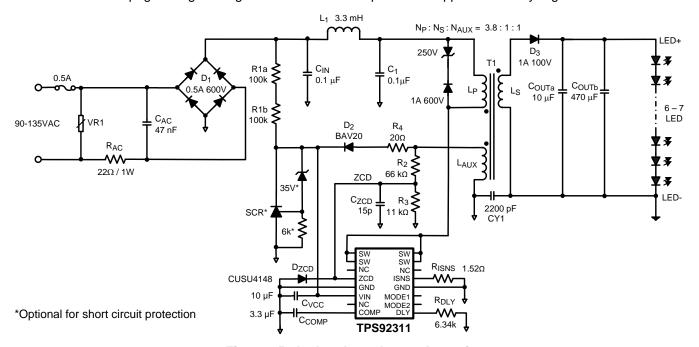


Figure 25. Isolated topology schematic



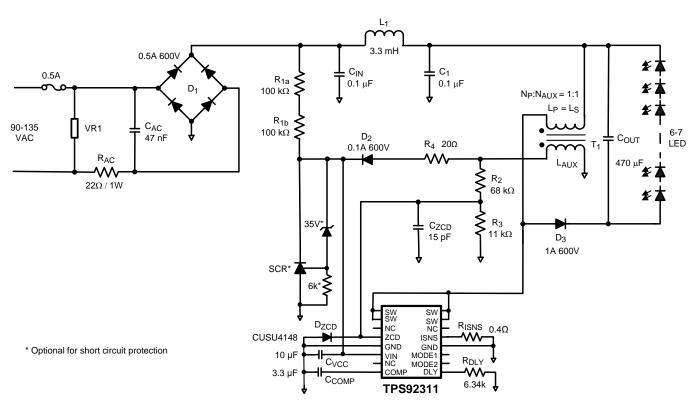


Figure 26. Non-isolated topology schematic



## **REVISION HISTORY**

Cr	Changes from Revision A (May 2013) to Revision B					
•	Changed layout of National Data Sheet to TI format	21				

Product Folder Links: TPS92311

22

#### IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products Applications

Audio www.ti.com/audio Automotive and Transportation www.ti.com/automotive Communications and Telecom **Amplifiers** amplifier.ti.com www.ti.com/communications **Data Converters** dataconverter.ti.com Computers and Peripherals www.ti.com/computers **DLP® Products** www.dlp.com Consumer Electronics www.ti.com/consumer-apps

DSP **Energy and Lighting** dsp.ti.com www.ti.com/energy Clocks and Timers www.ti.com/clocks Industrial www.ti.com/industrial Interface interface.ti.com Medical www.ti.com/medical logic.ti.com Logic Security www.ti.com/security

Power Mgmt power.ti.com Space, Avionics and Defense www.ti.com/space-avionics-defense

Microcontrollers <u>microcontroller.ti.com</u> Video and Imaging <u>www.ti.com/video</u>

RFID www.ti-rfid.com

OMAP Applications Processors <u>www.ti.com/omap</u> TI E2E Community <u>e2e.ti.com</u>

Wireless Connectivity <u>www.ti.com/wirelessconnectivity</u>